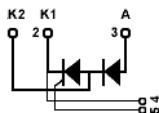


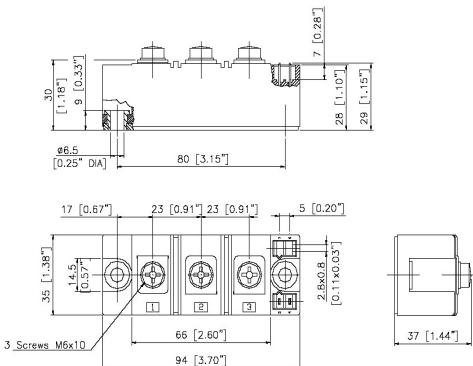
STD/SDT130

Thyristor-Diode Modules, Diode-Thyristor Modules

Dimensions in mm (1mm=0.0394")



Type	V_{RSM} V_{DSM}	V_{RRM} V_{DRM}
	V	V
STD/SDT130GK08	900	800
STD/SDT130GK12	1300	1200
STD/SDT130GK14	1500	1400
STD/SDT130GK16	1700	1600
STD/SDT130GK18	1900	1800



Symbol	Test Conditions	Maximum Ratings	Unit
I_{TRMS}, I_{FRMS} I_{TAVM}, I_{FAVM}	$T_{VJ}=T_{VJM}$ $T_c=85^\circ C$; 180° sine	300 130	A
I_{TSM}, I_{FSM}	$T_{VJ}=45^\circ C$ $V_R=0$	5500 5850	A
	$T_{VJ}=T_{VJM}$ $V_R=0$	4800 5100	
$\int i^2 dt$	$T_{VJ}=45^\circ C$ $V_R=0$	151000 142000	$A^2 s$
	$T_{VJ}=T_{VJM}$ $V_R=0$	115000 108000	
$(di/dt)_{cr}$	$T_{VJ}=T_{VJM}$ $f=50Hz, t_p=200\mu s$ $V_D=2/3V_{DRM}$ $I_G=0.5A$ $dI/dt=0.5A/\mu s$	150	$A/\mu s$
	repetitive, $I_T=500A$ non repetitive, $I_T=500A$	500	
$(dv/dt)_{cr}$	$T_{VJ}=T_{VJM};$ $V_{DR}=2/3V_{DRM}$ $R_{GK}=\infty$; method 1 (linear voltage rise)	1000	$V/\mu s$
P_{GM}	$T_{VJ}=T_{VJM}$ $I_T=I_{TAVM}$	120 60	W
P_{GAV}		8	W
V_{RGM}		10	V
T_{VJ} T_{VJM} T_{stg}		-40...+125 125 -40...+125	$^\circ C$
V_{ISOL}	50/60Hz, RMS $I_{ISOL}\leq 1mA$	3000 3600	$V\sim$
M_d	Mounting torque (M6) Terminal connection torque (M6)	2.25-2.75/20-25 4.5-5.5/40-48	Nm/lb.in.
Weight	Typical including screws	125	g

STD/SDT130

Thyristor-Diode Modules, Diode-Thyristor Modules

Symbol	Test Conditions	Characteristic Values	Unit
I_{RRM}, I_{DRM}	$T_{VJ}=T_{VJM}; V_R=V_{RRM}; V_D=V_{DRM}$	10	mA
V_T, V_F	$I_T, I_F=300A; T_{VJ}=25^\circ C$	1.36	V
V_{TO}	For power-loss calculations only ($T_{VJ}=125^\circ C$)	0.8	V
r_T		1.5	$m\Omega$
V_{GT}	$V_D=6V; T_{VJ}=25^\circ C$ $T_{VJ}=-40^\circ C$	2.5 2.6	V
I_{GT}	$V_D=6V; T_{VJ}=25^\circ C$ $T_{VJ}=-40^\circ C$	150 200	mA
V_{GD}	$T_{VJ}=T_{VJM}; V_D=2/3V_{DRM}$	0.2	V
I_{GD}		10	mA
I_L	$T_{VJ}=25^\circ C; t_p=30\mu s; V_D=6V$ $I_G=0.5A; dI/dt=0.5A/\mu s$	300	mA
I_H	$T_{VJ}=25^\circ C; V_D=6V; R_{GK}=\infty$	200	mA
t_{gd}	$T_{VJ}=25^\circ C; V_D=1/2V_{DRM}$ $I_G=0.5A; dI/dt=0.5A/\mu s$	2	us
t_q	$T_{VJ}=T_{VJM}; I_T=160A; t_p=200\mu s; -dI/dt=10A/\mu s$ $V_R=100V; dv/dt=20V/\mu s; V_D=2/3V_{DRM}$	typ. 150	us
Q_s	$T_{VJ}=T_{VJM}; I_T, I_F=300A; -dI/dt=50A/\mu s$	550	uC
I_{RM}		235	A
R_{thJC}	per thyristor/diode; DC current per module	0.23 0.115	K/W
R_{thJK}	per thyristor/diode; DC current per module	0.33 0.165	K/W
ds	Creeping distance on surface	12.7	mm
da	Strike distance through air	9.6	mm
a	Maximum allowable acceleration	50	m/s^2

FEATURES

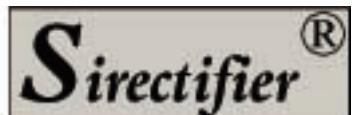
- * International standard package
- * Copper base plate
- * Planar passivated chips
- * Isolation voltage 3600 V~

APPLICATIONS

- * Motor control
- * Power converter
- * Heat and temperature control for industrial furnaces and chemical processes
- * Lighting control
- * Contactless switches

ADVANTAGES

- * Space and weight savings
- * Simple mounting
- * Improved temperature and power cycling
- * Reduced protection circuits



STD/SDT130

Thyristor-Diode Modules, Diode-Thyristor Modules

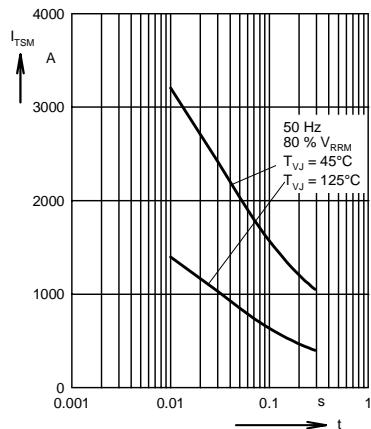


Fig. 1 Surge overload current
 I_{TSM}, I_{FSM} : Crest value, t : duration

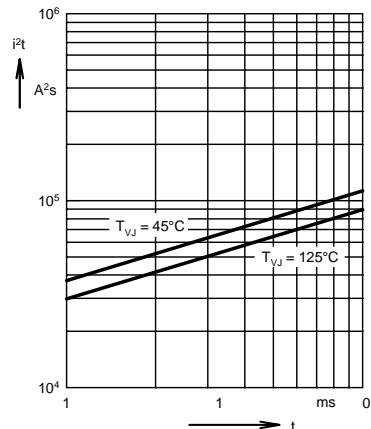


Fig. 2 $\int I^2 t$ versus time (1-10 ms)

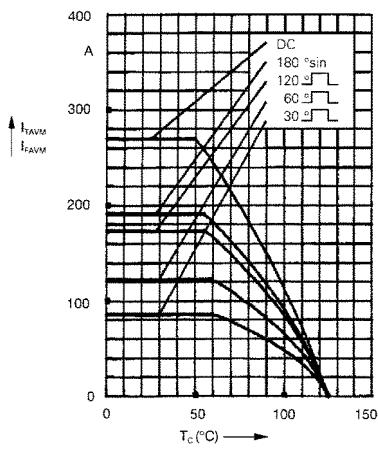


Fig. 2a Maximum forward current
at case temperature

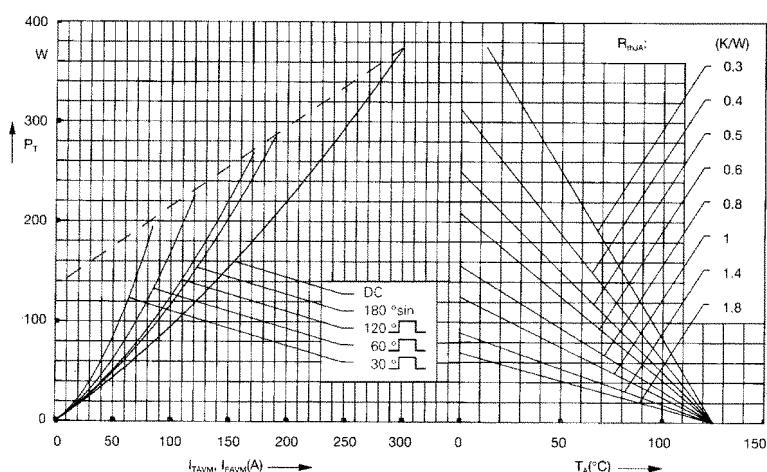


Fig. 3 Power dissipation versus on-state current and ambient temperature
(per thyristor or diode)

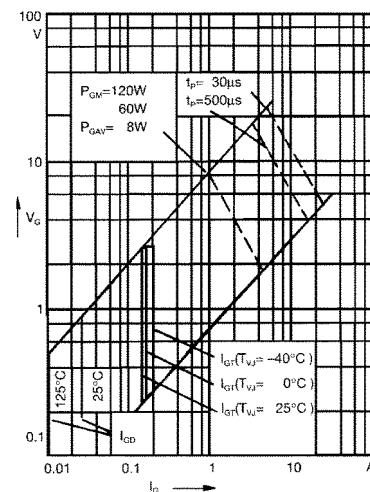


Fig. 4 Gate trigger characteristics

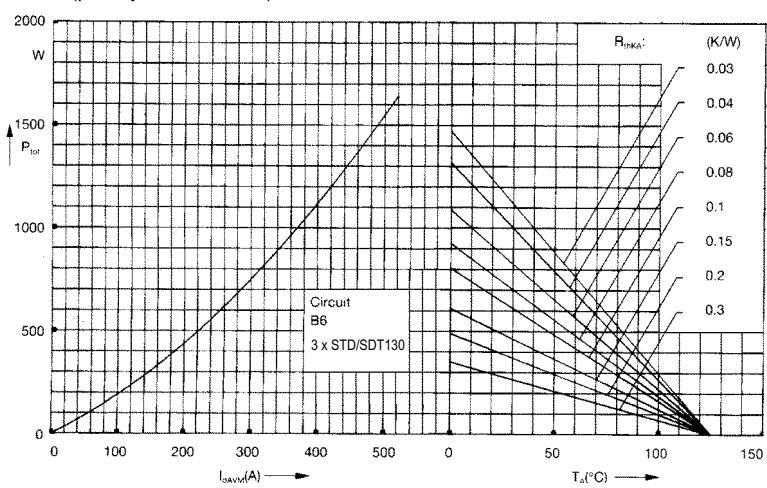


Fig. 5 Three phase rectifier bridge: Power dissipation versus direct output current
and ambient temperature

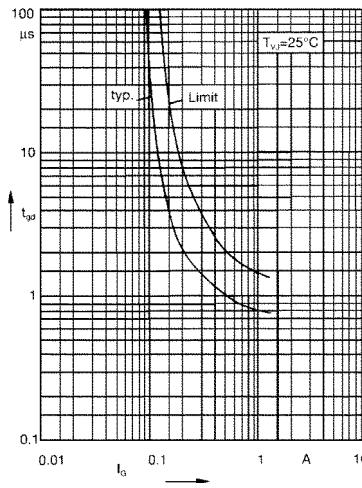


Fig. 6 Gate trigger delay time

STD/SDT130

Thyristor-Diode Modules, Diode-Thyristor Modules

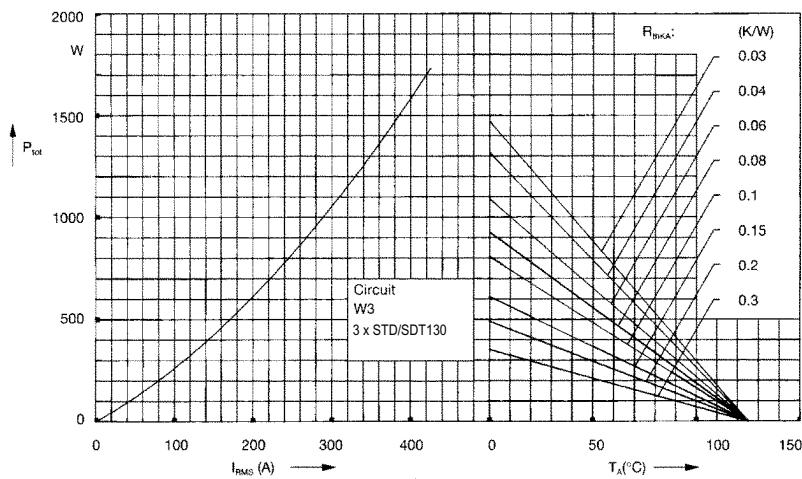


Fig. 7 Three phase AC-controller:
Power dissipation versus RMS
output current and ambient
temperature

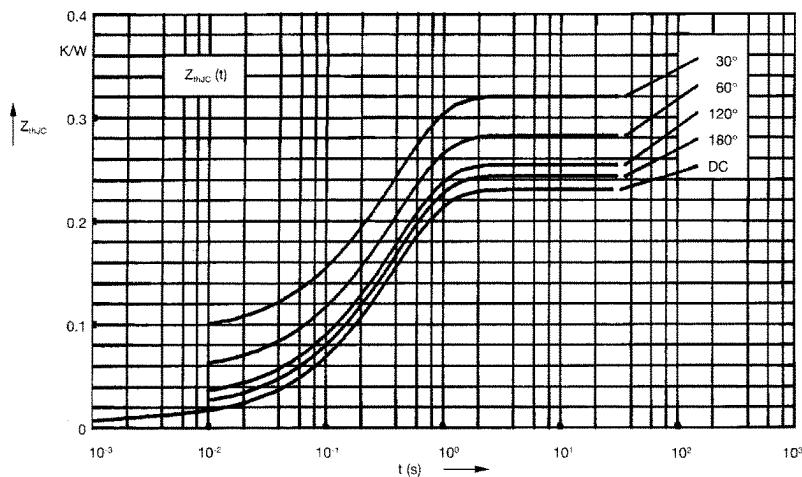


Fig. 8 Transient thermal impedance
junction to case (per thyristor or
diode)

R_{thJC} for various conduction angles d:

d	R_{thJC} (K/W)
DC	0.230
180°C	0.244
120°C	0.255
60°C	0.283
30°C	0.321

Constants for Z_{thJC} calculation:

i	R_{thi} (K/W)	t_i (s)
1	0.0095	0.001
2	0.0175	0.065
3	0.203	0.4

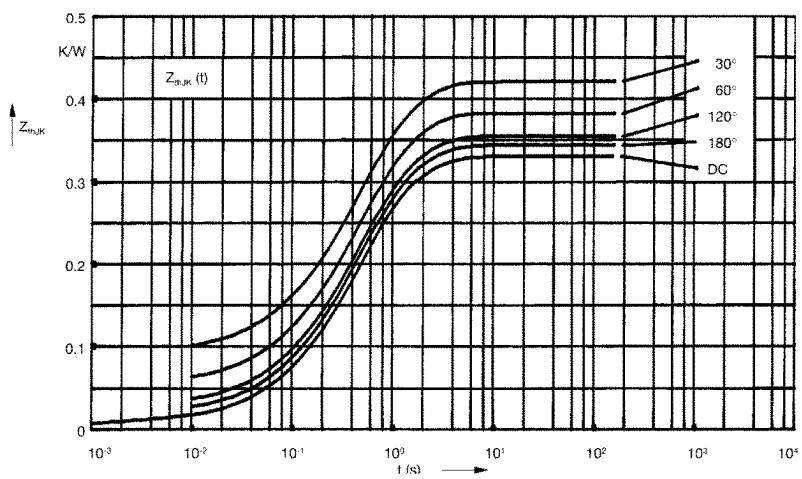


Fig. 9 Transient thermal impedance
junction to heatsink (per thyristor or
diode)

R_{thJK} for various conduction angles d:

d	R_{thJK} (K/W)
DC	0.330
180°C	0.344
120°C	0.355
60°C	0.383
30°C	0.421

Constants for Z_{thJK} calculation:

i	R_{thi} (K/W)	t_i (s)
1	0.0095	0.001
2	0.0175	0.065
3	0.203	0.4
4	0.1	1.29